1-1670615-2 ACTIVE

AMP | AMP MCP Connector System

TE Internal #: 1-1670615-2

Vertical, Wire-to-Board, 25 Position, 3 Row, 4mm / 5mm [.157in / .

197in] Centerline, Tin (Sn), Printed Circuit Board, AMP MCP

Connector System

View on TE.com >

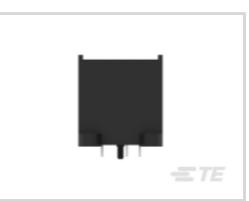


Automotive Parts > Automotive Connectors > Automotive Headers











PCB Mount Orientation: Vertical

Termination Method to PCB: Through Hole - Solder

Sealable: No

Centerline (Pitch): 4 mm, 5 mm [.157 in, .197 in]

Connector System: Wire-to-Board

Features

Product Type Features

Mixed & Hybrid Header	Yes
Header Type	Fully Shrouded
Connector Product Type	Connector Assembly
Sealable	No
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Vertical
Number of Positions	25
Number of Rows	3
Body Features	

Contact Features

Primary Product Color

Mating Tab Thickness	.6 mm, .8 mm[.024 in][.031 in]

Black



Contact Type	Tab
Mating Tab Width	1.5 mm, 3 mm[.059 in][.12 in]
Contact Mating Area Plating Material	Tin (Sn)
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
PCB Mount Retention	Without
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	4 mm, 5 mm[.157 in][.197 in]
Usage Conditions	
Operating Temperature (Max)	120 °C[248 °F]
Operating Temperature (Max) Operating Temperature Range	120 °C[248 °F] -40 – 120 °C[-40 – 248 °F]
Operating Temperature Range	
Operating Temperature Range Operation/Application	-40 – 120 °C[-40 – 248 °F]
Operating Temperature Range Operation/Application Circuit Application	-40 – 120 °C[-40 – 248 °F]

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量符合标准要求 No Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.



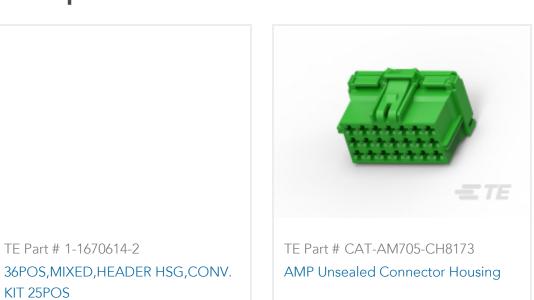
Solder Process Capability

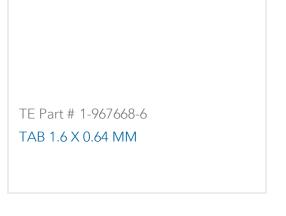
Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

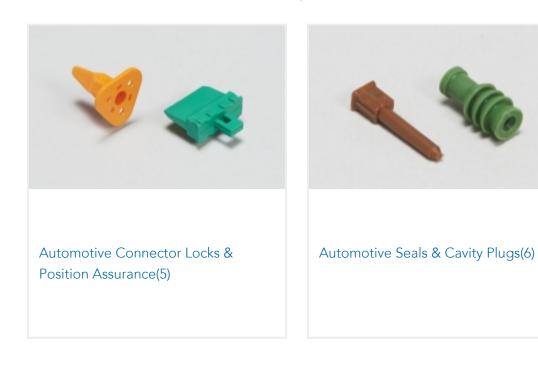
Compatible Parts



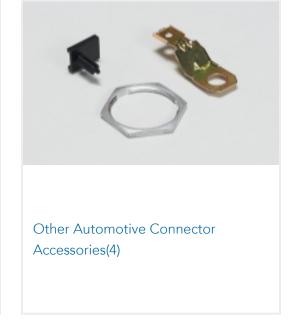




Also in the Series | AMP MCP Connector System







Customers Also Bought

















Documents

KIT 25POS

Product Drawings

36POS,MIXED,HEADER ASSY,CONV. KIT 25POS

English

CAD Files

Customer View Model

ENG_CVM_CVM_1-1670615-2_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1670615-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1670615-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English